

C1206C184F3JACTU

Specifications

Insulation Resistance

Aliases (C1206C184F3JAC7800) SMD Comm U2J, Ceramic, 0.18 uF, 1%, 25 VDC, U2J, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206, 1.5 mm



General Information	
Series	SMD Comm U2J
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	36 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1206
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	1.6mm +/-0.20mm
S	1.5mm MIN
В	0.5mm +/-0.25mm

Capacitance	0.18 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	1%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	U2J
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	-750+/-120 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0.1% Loss/Decade Hour: Referee Time is 1000 Hours

5.5556 GOhms

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2000

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